

NCE N-Channel Super Trench II Power MOSFET

Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

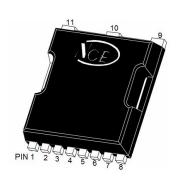
- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

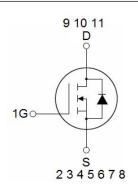
General Features

- V_{DS} =85V, I_D =360A $R_{DS(ON)}$ =1.2m Ω , typical @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

TOLL





Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP016N85LL	NCEP016N85LL	TOLL	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	85	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	360	Α
Drain Current-Continuous(T _C =100 ℃)	I _D (100℃)	275	Α
Pulsed Drain Current	I _{DM}	1440	Α
Maximum Power Dissipation	P _D	460	W
Derating factor		3.1	W/℃
Single pulse avalanche energy (Note 1)	E _{AS}	3200	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case	Rejc	0.33	°C/W



Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	85		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =85V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	$V_{GS}=\pm20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics			•			•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =180A	-	1.2	1.6	mΩ
Forward Transconductance	G FS	V _{DS} =5V,I _D =180A		210	-	S
Dynamic Characteristics						•
Input Capacitance	C _{lss}	\\ 40\\\\ 0\\	-	15800	-	PF
Output Capacitance	Coss	V_{DS} =40V, V_{GS} =0V, F=1.0MHz	-	2450	-	PF
Reverse Transfer Capacitance	Crss	F=1.UIVIHZ	-	111	-	PF
Switching Characteristics (Note 2)				1		•
Turn-on Delay Time	t _{d(on)}		-	43	-	nS
Turn-on Rise Time	tr	V_{DD} =40V, I_{D} =180A V_{GS} =10V, R_{G} =1.6 Ω	-	39	-	nS
Turn-Off Delay Time	t _{d(off)}		-	108	-	nS
Turn-Off Fall Time	t _f		-	40	-	nS
Total Gate Charge	Qg	1/ 40// 4004	-	245	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =40V,I _D =180A,	-	66		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	65		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =180A	-		1.2	V
Diode Forward Current	Is		-	-	360	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 180A	-	109	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	315	-	nC

Notes:

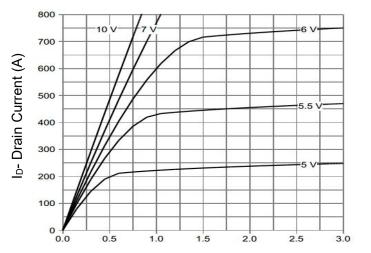
^{1.} EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=40V,VG=10V,L=0.5mH,Rg=25 Ω

^{2.} Guaranteed by design, not subject to production

^{3.} These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.

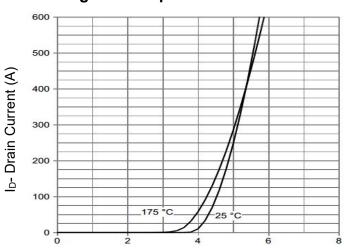


Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

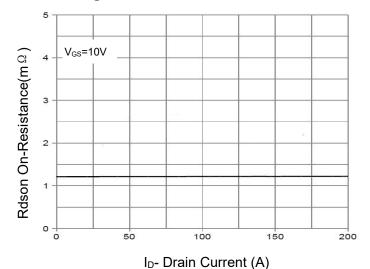
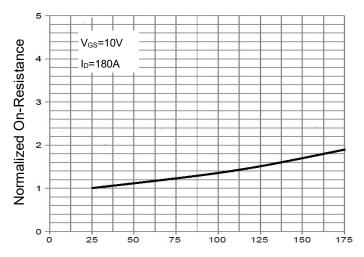
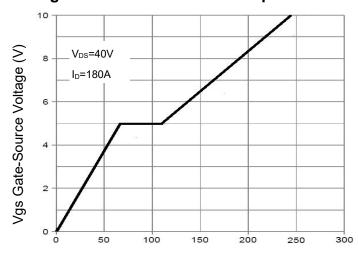


Figure 3 Rdson- Drain Current

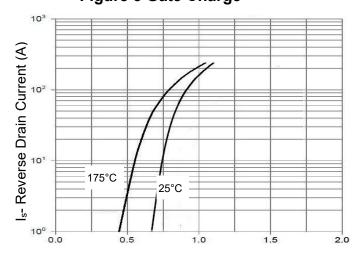


T_J-Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 5 Gate Charge



Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



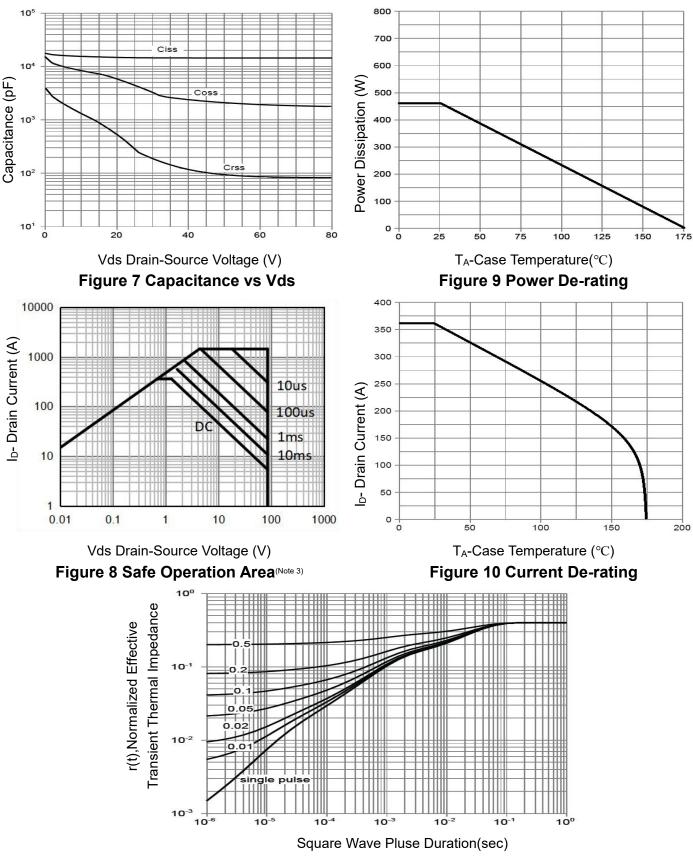
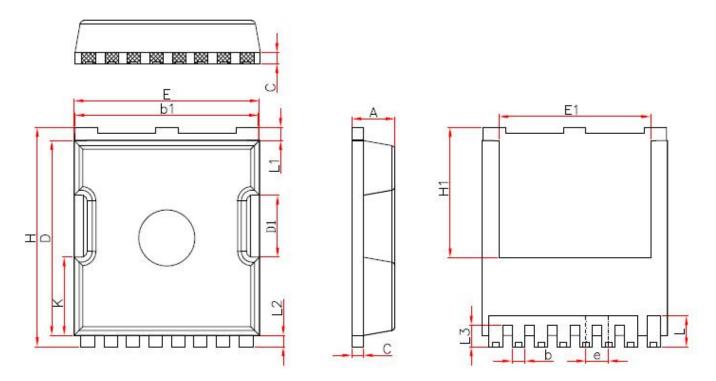


Figure 11 Normalized Maximum Transient Thermal Impedance



TOLL Package Information



Symbol	Mi	llimet	ers
VIII.	Min.	Nom.	Max.
A	2. 20	2.30	2.40
b	0.65	0.75	0.85
b1	9.70	9.80	9.90
C	0.50	0.60	0.70
D	10.30	10.40	10.50
D1	3.15	3.3	3.45
Е	9.70	9.90	10.10
E1	8.00	8.10	8.20
е	1.10	1.20	1.30
Н	11.6	11.7	11.8
H1	6.85	6.95	7.05
K	4.08	4.18	4.28
L	1.60	1.65	2.10
L1	0.60	0.70	0.80
L2	0.50	0.60	0.70
L3	1.05	1.20	1.30



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